LS
(Ref.: SG9-TD515-R1)

Source: ITU-T Study Group 9
Title: LS on AAP consent of two draft new Recommendations ITU-T J.198.2 (ex J.HiNoC3-PHY) and ITU-T J.198.3 (ex J.HiNoC3-MAC) and Agreement of draft new Supplement ITU-T J. Suppl. 12 (ex J.Sup-HiNoC)

**LIAISON STATEMENT**

**For action to:**
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**For information to:** ITU-T SG15, ETSI TC Cable, IEC TC100, CableLabs, SCTE, TTA, TTC, IEEE 802.3 Ethernet WG, CCSA.

**Approval:** ITU-T Study Group 9 meeting (Bogota, 23 November 2023)

**Deadline:** N/A

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**Abstract:** This liaison statement informs ITU-T SG15, ETSI TC Cable, IEC TC100, CableLabs, SCTE, TTA, TTC, IEEE 802.3 Ethernet WG, CCSA about two AAP consent of new Recommendations ITU-T J.198.2 (ex J.HiNoC3-PHY) and ITU-T J.198.3 (ex J.HiNoC3-MAC), and Agreement of the new Supplement ITU-T J.Suppl. 12 (ex J.Sup-HiNoC).

ITU-T Study Group 9 would like to inform you that during ITU-T SG9 meeting, 14-23 November 2023, Bogotá, Colombia, we started the approval process (AAP consent) for the work items ITU-T J.198.2 (ex J.HiNoC3-PHY) “Physical layer specification for third-generation HiNoC” and ITU-T J.198.3 (ex J.HiNoC3-MAC) “MAC layer specification for third-generation HiNoC”. We also would like to inform you that we agreed to publish the new Supplement ITU-T J.Suppl.12 (ex J.Sup-HiNoC) “Comparison between third-generation HiNoC and second-generation HiNoC”.

We look forward to a continued collaboration with your groups.

**Attachments:**

3. **SG9-TD518-R1**: Agreement - Draft new Supplement ITU-T J.Suppl. 12 (ex J.Sup-HiNoC) "Comparison between third-generation HiNoC and second-generation HiNoC"